





#### P-CHANNEL ENHANCEMENT MODE MOSFET

#### **Features**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)
- **ESD Protected Up To 3kV**
- "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

#### **Mechanical Data**

Case: SOT-523

Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020

Terminals: Finish — Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208

Terminal Connections: See Diagram

Marking Information: See Page 4

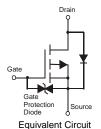
Ordering Information: See Page 4

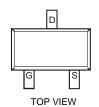
Weight: 0.002 grams (approximate)

SOT-523









 $\begin{tabular}{ll} \textbf{Maximum Ratings} & @T_A = 25^{\circ}C \ unless \ otherwise \ specified \end{tabular}$ 

Characteristic			Symbol	Value	Units
Drain-Source Voltage			$V_{DSS}$	-20	V
Gate-Source Voltage			$V_{GSS}$	±6	V
Drain Current (Note 1)	Steady State	$T_A = 25$ °C $T_A = 85$ °C	I <sub>D</sub>	-0.46 -0.33	Α
Pulsed Drain Current			I <sub>DM</sub>	-6	A

### **Thermal Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 1)	P <sub>D</sub>	0.27	W
Thermal Resistance, Junction to Ambient	$R_{ hetaJA}$	461	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

Notes:

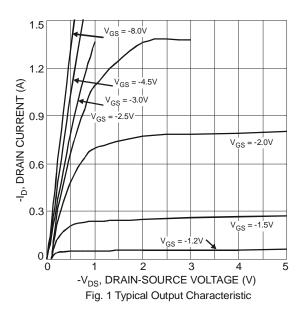
- 1. Device mounted on FR-4 PCB.
- 2. No purposefully added lead.
- 3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead\_free/index.php.

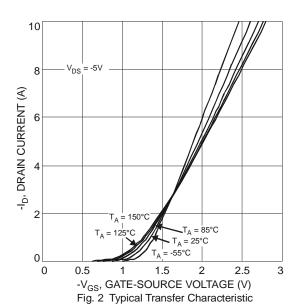


## **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

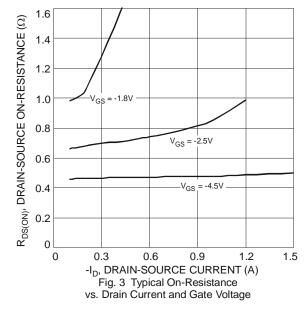
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 4)							
Drain-Source Breakdown Voltage		-20	-	-	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C	I <sub>DSS</sub>	-	-	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±2.0	μΑ	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.5	-	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
			0.5	0.7		$V_{GS} = -4.5V$ , $I_D = -350mA$	
Static Drain-Source On-Resistance	R <sub>DS</sub> (ON)	-	0.7	0.9	Ω	$V_{GS} = -2.5V$ , $I_{D} = -300$ mA	
	, ,		1.0	1.3		$V_{GS} = -1.8V, I_{D} = -150mA$	
Forward Transfer Admittance	Y <sub>fs</sub>	-	0.9	-	S	$V_{DS} = -10V, I_{D} = -250mA$	
Diode Forward Voltage (Note 4)			-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$	
Diode Forward Voltage (Note 4)   V <sub>SD</sub>   -0.8   -1.2   V   V <sub>GS</sub> = 0V, I <sub>S</sub> = -150mA   <b>DYNAMIC CHARACTERISTICS</b>							
Input Capacitance	C <sub>iss</sub>	-	59.76	-	pF	101/11/	
Output Capacitance	Coss	-	12.07	-	pF	$V_{DS} = -16V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	6.36	-	pF	1 = 1.0WH12	
Total Gate Charge	Qg	-	622.4	-	рC	1 4 5 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Gate-Source Charge	$Q_{gs}$	-	100.3	-	рC	$V_{GS} = -4.5V, V_{DS} = -10V,$	
Gate-Drain Charge	Q <sub>gd</sub>	-	132.2	-	рC	$I_D = -250 \text{mA}$	
Turn-On Delay Time	t <sub>D(on)</sub>	-	5.1	-	ns	10/1/	
Turn-On Rise Time	t <sub>r</sub>	-	8.1	-	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$	
Turn-Off Delay Time	t <sub>D(off)</sub>	-	28.4	-	ns	$R_L = 47\Omega, R_G = 10\Omega,$ $I_D = -200\text{mA}$	
Turn-Off Fall Time	t <sub>f</sub>	-	20.7	-	ns	7ID = -200IIIA	

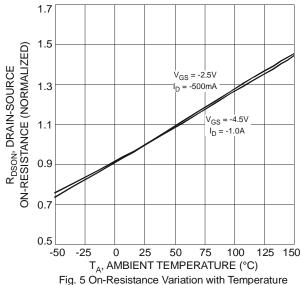
Notes: 4. Short duration pulse test used to minimize self-heating effect.











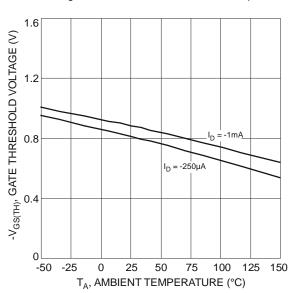
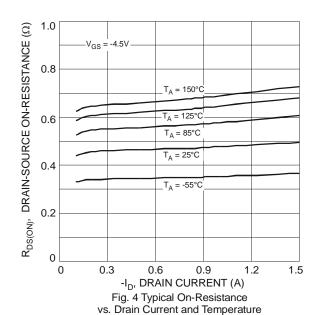
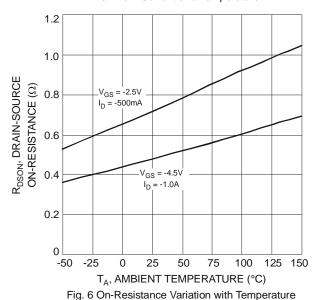


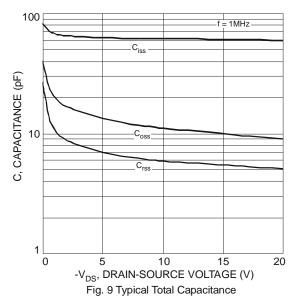
Fig. 7 Gate Threshold Variation vs. Ambient Temperature





10 8 8 T<sub>A</sub> = 25°C 0 0.2 0.4 0.6 0.8 1.0 1.2 -V<sub>SD</sub>, SOURCE-DRAIN VOLTAGE (V) Fig. 8 Diode Forward Voltage vs. Current





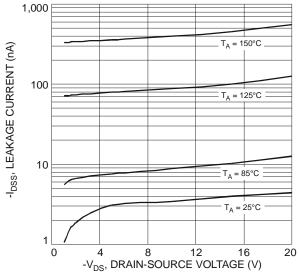
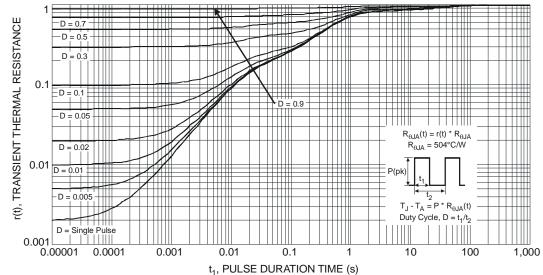


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage



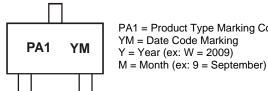
### Ordering Information (Note 5)

Ī	Part Number	Case	Packaging
	DMG1013T-7	SOT-523	3000/Tape & Reel

Fig. 11 Transient Thermal Response

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf. Notes:

## **Marking Information**



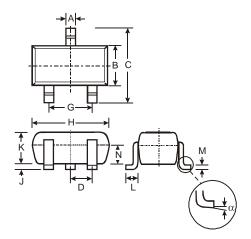
PA1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: W = 2009)

Date Code Key

Year	2009	9	2010		2011	20	12	2013		2014	2	2015
Code	W		X		Υ	2	Z	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

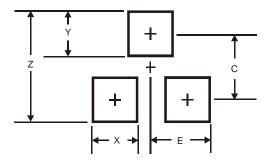


## **Package Outline Dimensions**



SOT-523					
Dim	Min	Max	Тур		
Α	0.15	0.30	0.22		
В	0.75	0.85	0.80		
С	1.45	1.75	1.60		
D			0.50		
G	0.90	1.10	1.00		
Н	<b>H</b> 1.50		1.60		
J	0.00	0.10	0.05		
K	0.60	0.80	0.75		
L	0.10	0.30	0.22		
M	0.10	0.20	0.12		
N	0.45	0.65	0.50		
α	0°	8°			
All	All Dimensions in mm				

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	1.8
Х	0.4
Y	0.51
С	1.3
Е	0.7



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